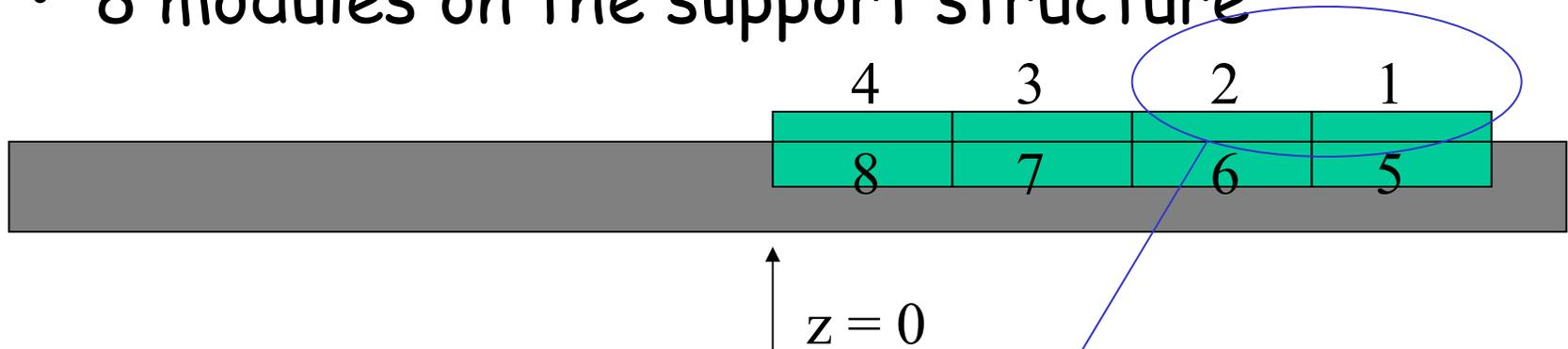


Pedestal Splitting

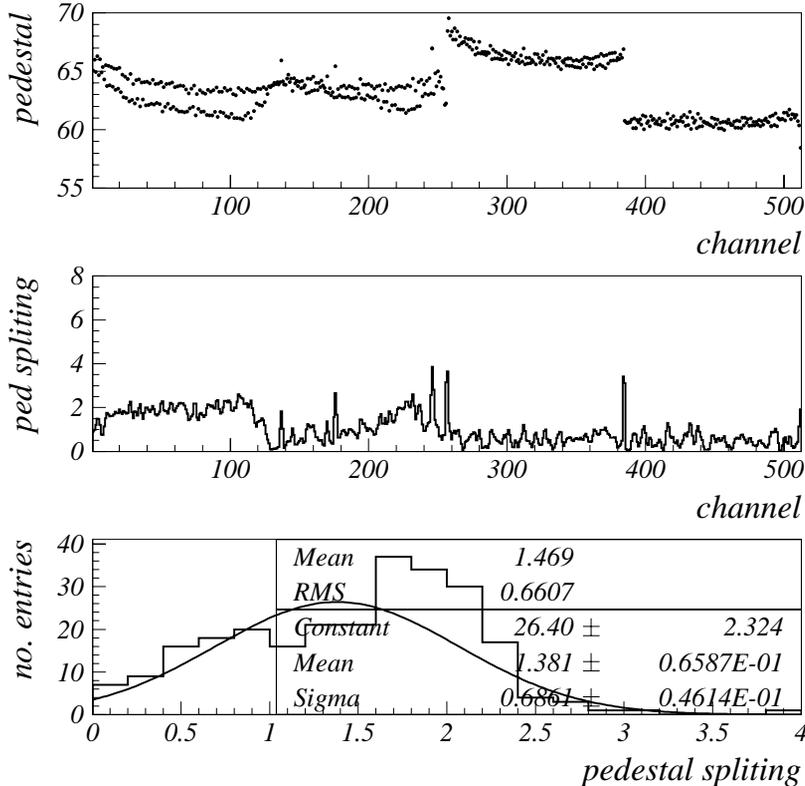
- 8 modules on the support structure



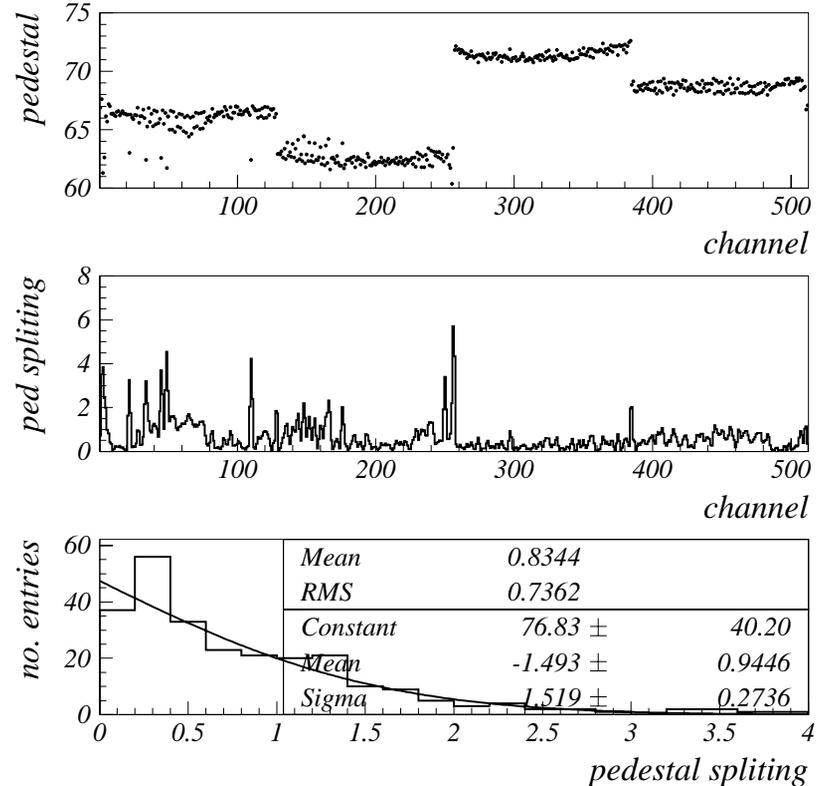
- Read out only 1 and 2 in this study
 - We know `cal_sr` in 2 has contribution to 1
- HV = 50 V
- BW = 4 with 132 ns integration time

Comparison with the run 2b L0

new L0



run 2b L0

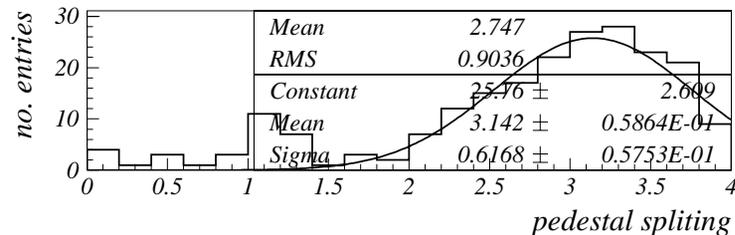
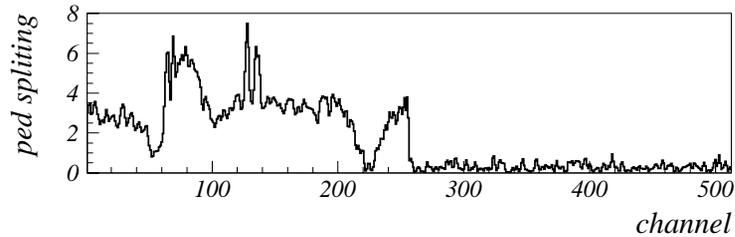
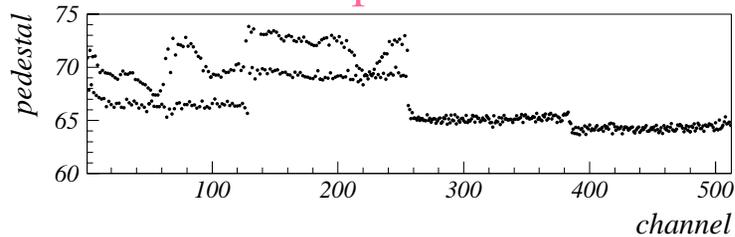


- run 2b L0 does not have the splitting, although there is tiny effect by cal_sr
- ← difference is the distance between hybrid and the analog cable underneath

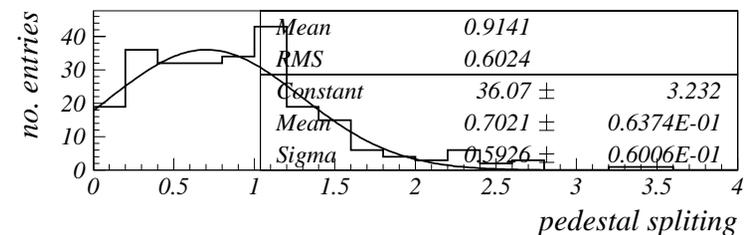
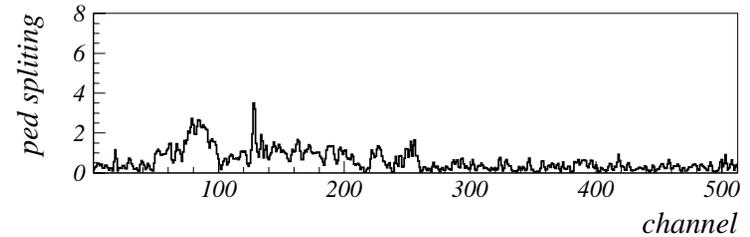
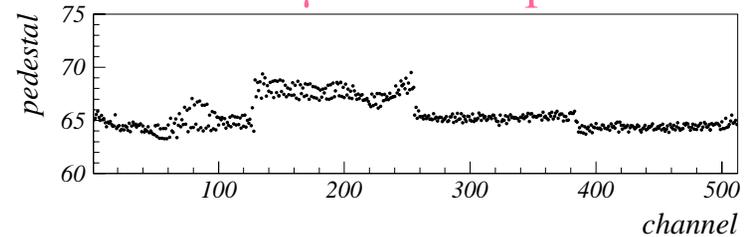
Spacer between hybrid and analog cable



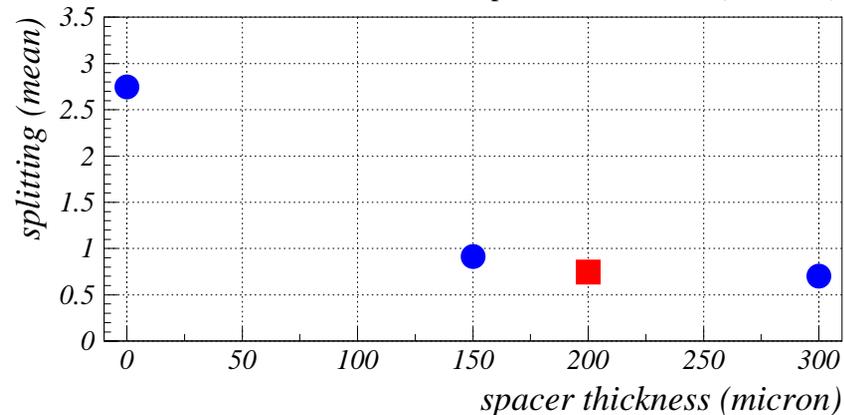
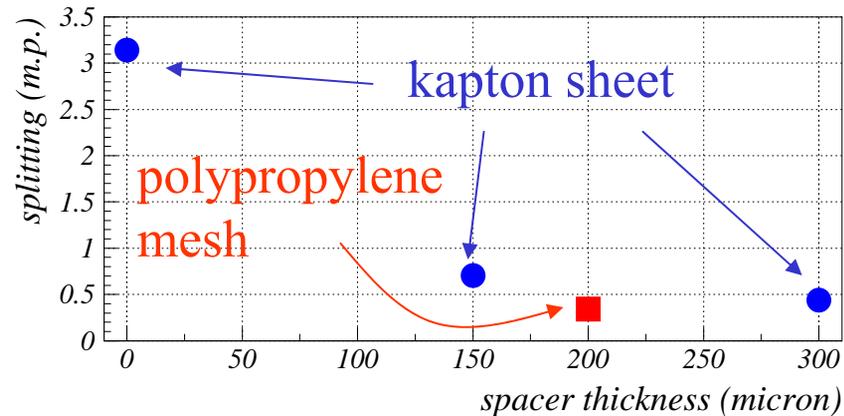
no spacer



150 μm thick spacer

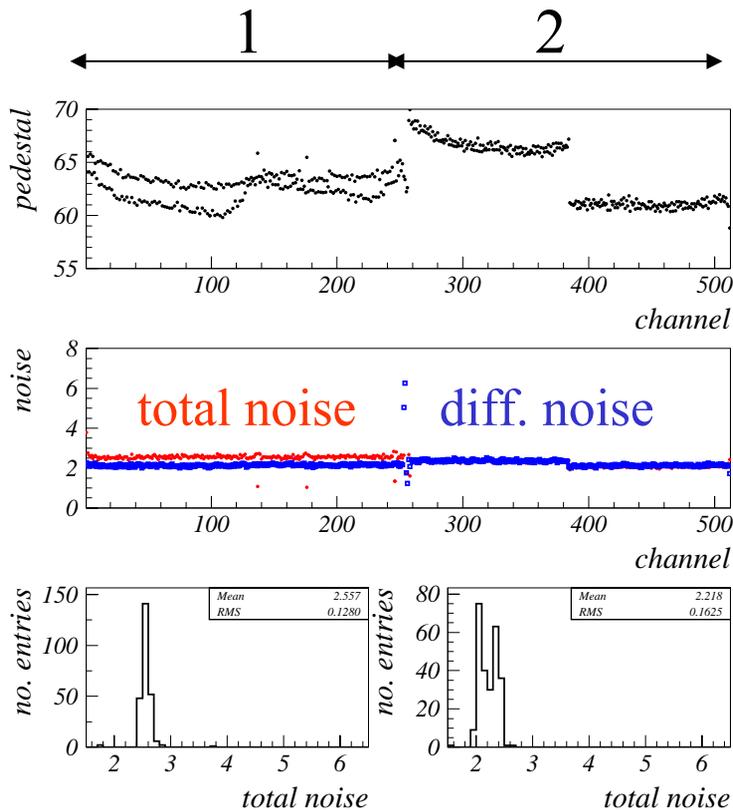
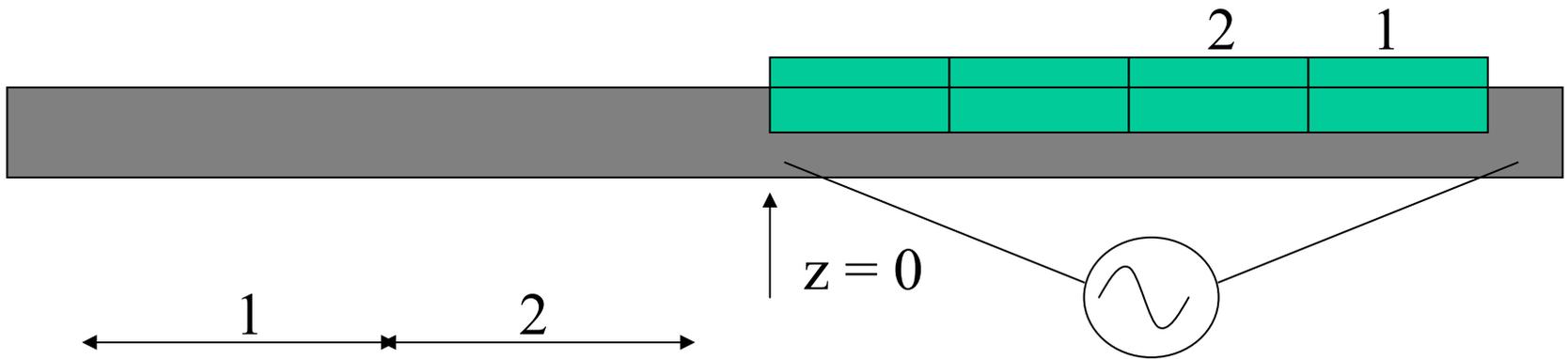


Dependence on spacer thickness



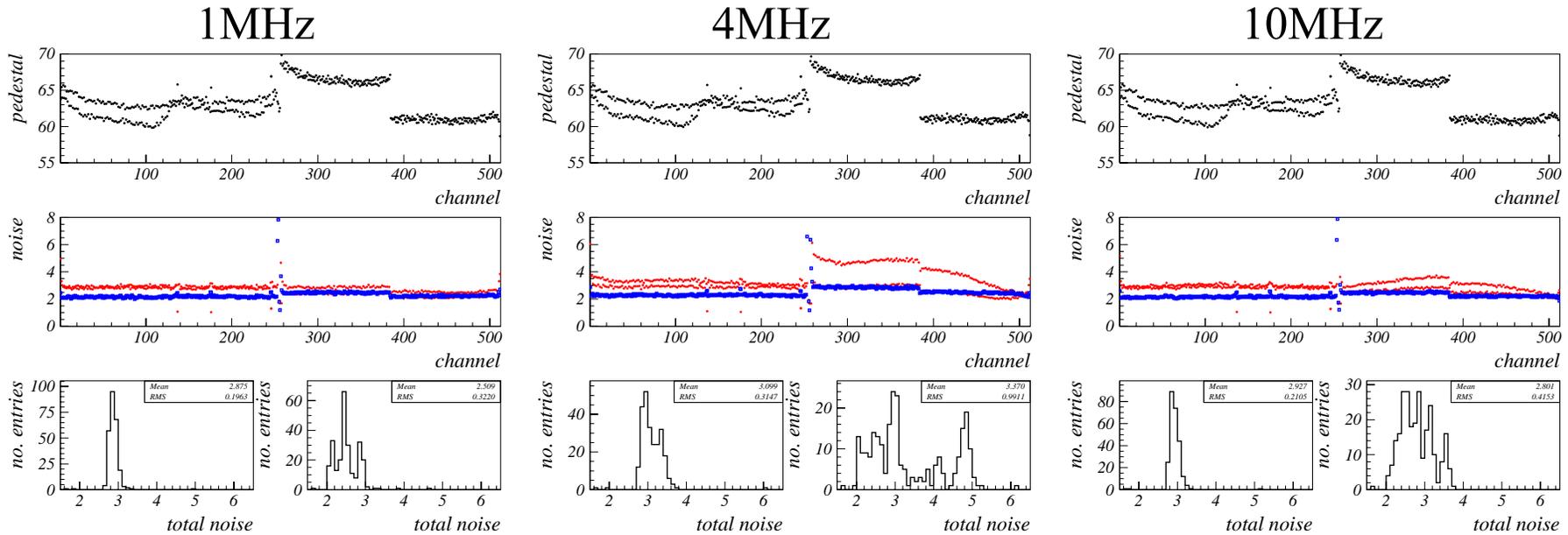
- clear dependence on the spacer thickness
- another measurement by Daekwang

Noise study using pulse generator



- Pulse generator connected to the support structure through the copper mesh
- Due to the inductance of cables (?), there is small pickup on the module 1 without any pulse. See the left plot

Some measurements



- Larger effect
 - on module 2
 - on top analog cable in a module
- ➔ closer to the support structure, effect is smaller
- Real time pedestal subtraction removes this coherent noise completely

Summary

- Pedestal splitting
 - coupling between analog cable and hybrid, on top of the cal_sr
 - need some ($\sim 150\mu\text{m}$?) space
- Noise study with pulse generator
 - effect is smaller when the frequency is $< 1\text{MHz}$ or $> 10\text{MHz}$
 - more detailed study by Daekwang
 - frequency dependence
 - amplitude dependence
 - closer the support structure, noise is smaller
 - two hypotheses
 - because of poor ground connection, actual ground comes from capacitive coupling of analog cable
 - ground loop among sensor, analog cable, hybrid and support structure
 - testing with single point ground at sensor side will decide the correct theory